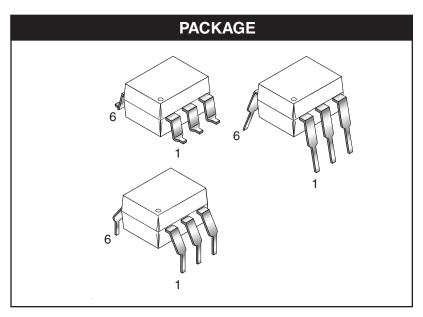
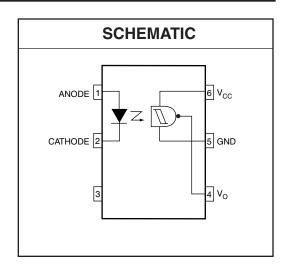


H11N1-M H11N2-M H11N3-M





DESCRIPTION

The H11NX-M series has a high speed integrated circuit detector optically coupled to an AlGaAs infrared emitting diode. The output incorporates a Schmitt trigger, which provides hysteresis for noise immunity and pulse shaping. The detector circuit is optimized for simplicity of operation and utilizes an open collector output for maximum application flexibility.

FEATURES

- High data rate, 5 MHz typical (NRZ)
- Free from latch up and oscilliation throughout voltage and temperature ranges.
- Microprocessor compatible drive
- Logic compatible output sinks 16 mA at 0.5 V maximum
- · Guaranteed on/off threshold hysteresis
- · Wide supply voltage capability, compatible with all popular logic systems
- High common mode transient immunity, 2000 V/µs minimum
- Fast switching t_r = 7.5ns typical, t_f = 12ns typical
- Underwriter Laboratory (UL) recognized—file #E90700
- VDE recognized File#102497 Add option V (e.g., H11N1VM)

APPLICATIONS

- Logic to logic isolator
- · Programmable current level sensor
- Line receiver—eliminate noise and transient problems
- A.C. to TTL conversion—square wave shaping
- · Interfaces computers with peripherals
- Isolated power MOS driver for power supplies



H11N1-M H11N2-M H11N3-M

ABSOLUTE MAXIMUM RATINGS						
Parameters	Symbol	Device	Value	Units		
TOTAL DEVICE						
Storage Temperature	T _{STG}	All	-55 to +150	°C		
Operating Temperature	T _{OPR}	All	-40 to +85	°C		
Lead Solder Temperature	T _{SOL}	All	260 for 10 sec	°C		
Total Device Power Dissipation @ 25°C			250	mW		
Derate Above 25°C			2.94	mW/°C		
EMITTER						
Continuous Forward Current	I _F	All	30	mA		
Reverse Voltage	V _R	All	6	V		
Forward Current - Peak (1 µs pulse, 300 pps)	I _F (pk)	All	1.0	А		
LED Power Dissipation 25°C Ambient	P _D	All	120	mW		
Derate Linearly From 25°C	LD.	All	1.41	mW/°C		
DETECTOR						
Detector Power Dissipation @ 25°C	P _D	All	150	mW		
Derate Linearly from 25°C	'D	All	1.76	mW/°C		
V ₄₅ Allowed Range	V _O	All	0 to 16	V		
V ₆₅ Allowed Range	V _{CC}	All	0 to 16	V		
I ₄ Output Current	Io	All	50	mA		

INDIVIDUAL COMPONENT CHARACTERISTICS						
Parameters	Test Conditions	Symbol	Device	Min	Тур*	Max
EMITTER						
Input Forward Voltage	I _F = 10 mA	V _F	All		1.4	2
Input Forward Voltage	I⊏ = 0.3 mA	1 ^v F	All	0.75	1.25	

ELECTRICAL CHARACTERISTICS ($T_A = 0.70^{\circ}C$ Unless otherwise specified.)

 $I_F = 0.3 \text{mA}, V_{CC} = V_O = 15 \text{V}$

- 1	Input Forward Voltage	•	l V _F	l All				\/
	input i orward voltage	$I_F = 0.3 \text{ mA}$	*F	All	0.75	1.25		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
	Reverse Current	V _R = 5 V	I _R	All			10	μΑ
	Capacitance	V = 0, f = 1.0 MHz	CJ	All			100	pF
	DETECTOR							
	Operating Voltage Range		V _{CC}	All	4		15	V
	Supply Current	$I_F = 0, V_{CC} = 5V$	I _{CC(off)}	All		6	10	mA

^{*}Typical values at T_A = 25°C

Output Current, High

 I_{OH}

ΑII

μΑ

100

Units



H11N1-M H11N2-M H11N3-M

TRANSFER CHARACTERISTICS							
DC Characteristics	Test Conditions	Symbol	Device	Min	Тур*	Max	Units
Supply Current	I _F = 10mA, V _{CC} = 5V	I _{CC(on)}	All		6.5	10	mA
Output Voltage, low	R_L =270 Ω , V_{CC} =5 V , I_F = $I_{F(on)}$ max.	V _{OL}	All			0.5	V
	D 0700 V 5V		H11N1-M	0.8		3.2	
Turn-On Threshold Current	R _L =270 Ω , V _{CC} = 5V note 1	I _{F(on)}	H11N2-M	2.3		5	mA
			H11N3-M	4.1		10	
Turn-Off Threshold Current	$R_L = 270\Omega, V_{CC} = 5V$	I _{F(off)}	All	0.3			mA
Hysteresis Ratio	$R_L = 270\Omega, V_{CC} = 5V$	I _{F(off)} /I _{F(on)}	All	0.65		0.95	
AC Characteristics	Test Conditions	Symbol	Device	Min	Тур	Max	Units
SWITCHING SPEED							
Propagation delay time High to Low	C=120pF, t_P =1 μ s, R_E : Note 2 Fig. 1	t _{PHL}	All		100	330	ns
Rise Time	C=120pF, t _P =1μs, R _E : Note 2 Fig. 1	t _r	All		7.5		ns
Propagation delay time Low to High	C=120pF, t _P =1μs, R _E : Note 2 Fig. 1	t _{PLH}	All		150	330	ns
Fall time	C=120pF, t_P =1 μ s, R_E : Note 2 Fig. 1	t _f	All		12		ns
Data Rate			All		5		MHz

ISOLATION CHARACTERISTICS						
Parameters	Test Conditions	Symbol	Min	Тур*	Max	Units
Input-Output Isolation Voltage	f = 60 Hz, t =1 sec.	V _{ISO}	7500			V _{PEAK}
Isolation Capacitance	V _{I-O} = 0V, f = 1 MHz	C _{ISO}		0.4	0.6	pF
Isolation Resistance	V _{I-O} = ±500 VDC	R _{ISO}	10 ¹¹			Ω

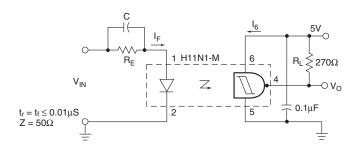
^{*}Typical values at $T_A = 25$ °C

NOTES:

- 1. Maximum $I_{F(ON)}$ is the maximum current required to trigger the output. For example, a 3.2mA maximum trigger current would require the LED to be driven at a current greater than 3.2mA to guarantee the device will turn on. A 10% guard band is recommended to account for degradation of the LED over its lifetime. The maximum allowable LED drive current is 30mA.
- 2. H11N1: $R_E = 910\Omega$ H11N2: $R_E = 560\Omega$



H11N1-M H11N2-M H11N3-M



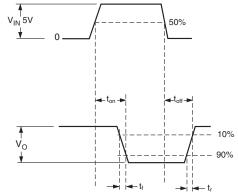
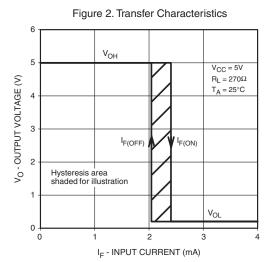
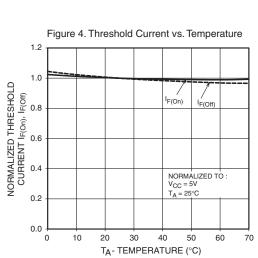
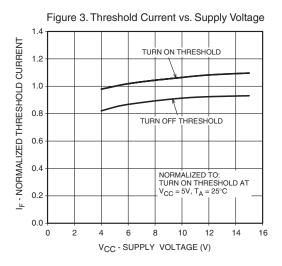
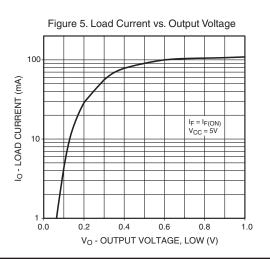


Figure 1. Switching Test Circuit and Waveforms











H11N1-M H11N2-M H11N3-M

Figure 6. Supply Current vs. Supply Voltage

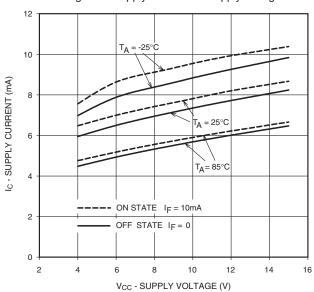
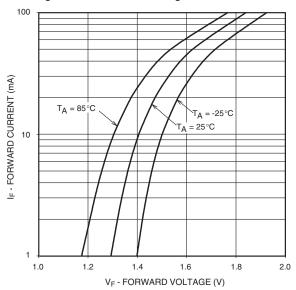
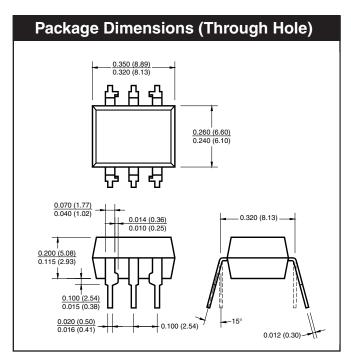


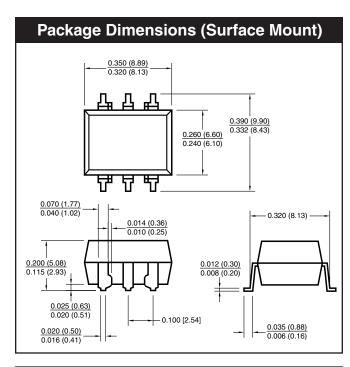
Figure 7. LED Forward Voltage vs. Forward Current

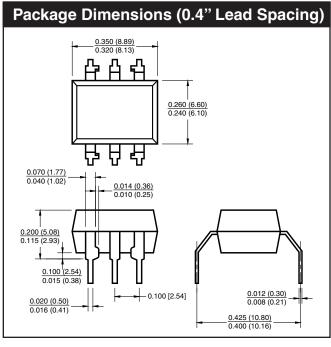


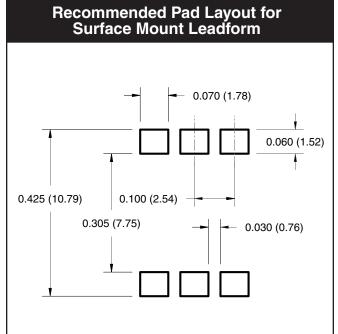


H11N1-M H11N2-M H11N3-M







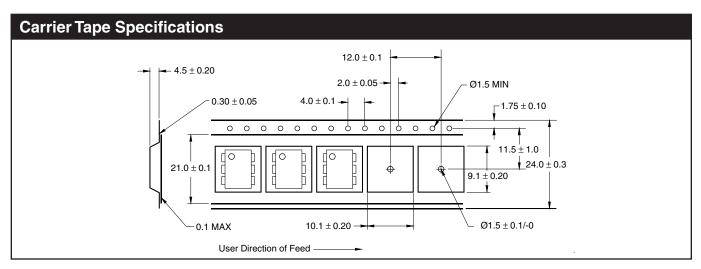




H11N1-M H11N2-M H11N3-M

ORDERING INFORMATION

Option/Order Entry Identifier	Description
S	Surface Mount Lead Bend
SR2	Surface Mount; Tape and reel
Т	0.4" Lead Spacing
V	VDE 0884
TV	VDE 0884, 0.4" Lead Spacing
SV	VDE 0884, Surface Mount
SR2V	VDE 0884, Surface Mount, Tape & Reel



NOTE

All dimensions are in inches (millimeters)



H11N1-M H11N2-M H11N3-M

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